

1. Product Features

1.1 Electrical features

- $V_{CES}=1200V$
- $I_{C\ nom}=450A / I_{CRM}=900A$
- Low switching losses
- Low inductance
- Fast switching and short tail current
- High power and thermal cycling capability



Figure1 IGBT Module

1.2 Mechanical features

- High power and thermal cycling capability
- Al_2O_3 substrate with low thermal resistance
- Copper base plate

2. Typical Applications

- Switching mode power supply
- Drive inverters with brake system
- Uninterruptible power supply
- AC and DC servo drive amplifier

3. Description

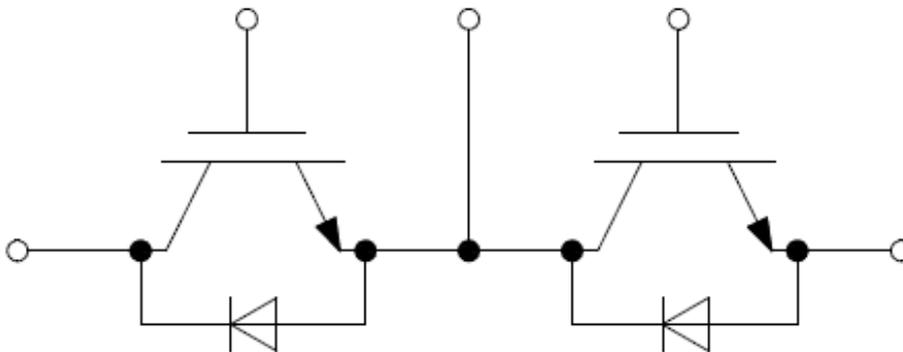


Figure 2 Half Bridge

4. IGBT, Inverter

4.1 Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Collector-emitter voltage 集电极—发射极间电压	$T_{vj} = 25^{\circ}\text{C}$	V_{CES}	1200	V
Continuous DC collector current 连续集电极电流	$T_C = 85^{\circ}\text{C}, T_{vj}, \text{max} = 150^{\circ}\text{C}$	$I_{C\text{nom}}$	450	A
Repetitive peak collector current 集电极峰值电流	$t_P = 1\text{ms}$	I_{CRM}	1200	A
Total power dissipation 总功率损耗	$T_C = 25^{\circ}\text{C}, T_{vj}, \text{max} = 175^{\circ}\text{C}$	P_{tot}	1800	W
Gate-emitter peak voltage 栅极—发射极峰值电压		V_{GES}	+/- 20	V

4.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage 集电极—发射极饱和电压	$I_C = 450\text{A}, V_{GE} = 15\text{V}$	$T_{vj} = 25^{\circ}\text{C}$		1.45	1.90	V
		$T_{vj} = 125^{\circ}\text{C}$		1.60		V
		$T_{vj} = 150^{\circ}\text{C}$		1.65		V
Gate threshold voltage 栅极阈值电压	$I_C = 17.1\text{mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$	$V_{GE,th}$	5.0	5.8	6.5	V
Gate charge 栅极电荷	$V_{GE} = -15\text{V} \dots +15\text{V}$	Q_G		5.2		μC
Internal gate resistor 内部栅极电阻	$T_{vj} = 25^{\circ}\text{C}$	R_{Gint}		0.7		Ω
Input capacitance 输入电容	$f=1\text{MHz}, T_{vj}=25^{\circ}\text{C}, V_{CE}=25\text{V}, V_{GE}=0\text{V}$	C_{ies}		64		nF
Reverse transfer capacitance 反向传输电容	$f=1\text{MHz}, T_{vj}=25^{\circ}\text{C}, V_{CE}=25\text{V}, V_{GE}=0\text{V}$	C_{res}		0.5		nF
Collector-emitter cut-off current 集电极-发射极截止电流	$V_{CE} = 1200\text{V}, V_{GE} = 0\text{V}, T_{vj} = 25^{\circ}\text{C}$	I_{CES}			3	mA
Gate-emitter leakage current 栅极-发射极漏电流	$V_{CE} = 0\text{V}, V_{GE} = 20\text{V}, T_{vj} = 25^{\circ}\text{C}$	I_{GES}			300	nA
Turn-on delay time, inductive load 开通延迟时间	$I_C = 450\text{A}, V_{CE} = 600\text{V}$ $V_{GE} = +15/-15\text{V}$ $R_{G,on} = 1.6\Omega$	$T_{vj} = 25^{\circ}\text{C}$		0.17		us
		$T_{vj} = 125^{\circ}\text{C}$		0.19		us
		$T_{vj} = 150^{\circ}\text{C}$		0.20		us
Rise time, inductive load 上升时间	$I_C = 450\text{A}, V_{CE} = 600\text{V}$ $V_{GE} = +15/-15\text{V}$ $R_{G,on} = 1.6\Omega$	$T_{vj} = 25^{\circ}\text{C}$		0.08		us
		$T_{vj} = 125^{\circ}\text{C}$		0.09		us
		$T_{vj} = 150^{\circ}\text{C}$		0.09		us

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Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Turn-off delay time, inductive load 关断延迟时间	$I_C = 450A, V_{CE} = 600V$ $V_{GE} = +15/-15V$ $R_{G,off} = 1.6\Omega$	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$ $T_{vj} = 150^\circ C$	$t_{d,off}$		0.50	us
					0.54	us
					0.55	us
Fall time, inductive load 下降时间	$I_C = 450A, V_{CE} = 600V$ $V_{GE} = +15/-15V$ $R_{G,off} = 1.6\Omega$	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$ $T_{vj} = 150^\circ C$	t_f		0.18	us
					0.31	us
					0.45	us
Turn-on energy loss per pulse 开通损耗能量	$I_C = 450A, V_{CE} = 600V, L_s=40nH$ $V_{GE} = +15/-15V, di/dt = 4200A/\mu s$ $R_{G,on} = 1.6\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$ $T_{vj} = 150^\circ C$	E_{on}		19.9	mJ
					38.0	mJ
					43.6	mJ
Turn-off energy loss per pulse 关断损耗能量	$I_C = 450A, V_{CE} = 600V, L_s=40nH$ $V_{GE} = +15/-15V, dv/dt = 3800V/\mu s$ $R_{G,off} = 1.6\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$ $T_{vj} = 150^\circ C$	E_{off}		45.3	mJ
					58.8	mJ
					61.7	mJ
SC data 短路数据	$V_{GE} \leq 15V, V_{CC} = 600V, t_P \leq 8\mu s, T_{vj} = 150^\circ C,$ $C_{GE} = 0.0\mu F, V_{CEmax} = V_{CES} - L_{sCE} \cdot di/dt$	I_{sc}		2640		A
Thermal resistance, junction to case 结-外壳热阻	Per IGBT	$R_{th,jc}$			0.083	K/W

5. Diode, Inverter

5.1 Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Repetitive peak reverse voltage 反向重复峰值电压	$T_{vj} = 25^\circ C$	V_{RRM}	1200	V
Continuous DC forward current 连续正向直流电流		I_F	450	A
Repetitive peak forward current 正向重复峰值电流	$t_P = 1\text{ ms}$	I_{FRM}	900	A

5.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Forward voltage 正向电压	$I_F = 450\text{ A}, V_{GE} = 0\text{ V}$	V_F		2.00	2.40	V
				1.65		V
				1.60		V

(table continues...) 待续

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Peak reverse recovery current 反向恢复峰值电流	$I_F = 450A, V_R = 600V$ $V_{GE} = -15V, -di_F/dt = 1200 A/\mu s$ $(T_{vj}=150^\circ C)$	I_{RM}		270		A
				380		A
				390		A
Recovered charge 恢复电荷	$I_F = 450A, V_R = 600V$ $V_{GE} = -15V, -di_F/dt = 1200 A/\mu s$ $(T_{vj}=150^\circ C)$	Q_r		28.5		μC
				69.3		μC
				73.7		μC
Reverse recovery energy 反向恢复损耗 (每脉冲)	$I_F = 450A, V_R = 600V$ $V_{GE} = -15V, -di_F/dt = 1200 A/\mu s$ $(T_{vj}=150^\circ C)$	E_{rec}		7.3		mJ
				17.0		mJ
				20.4		mJ
Thermal resistance, junction to case 结-外壳热阻	Per diode	$R_{th,JC}$			0.164	K/W

6. Module

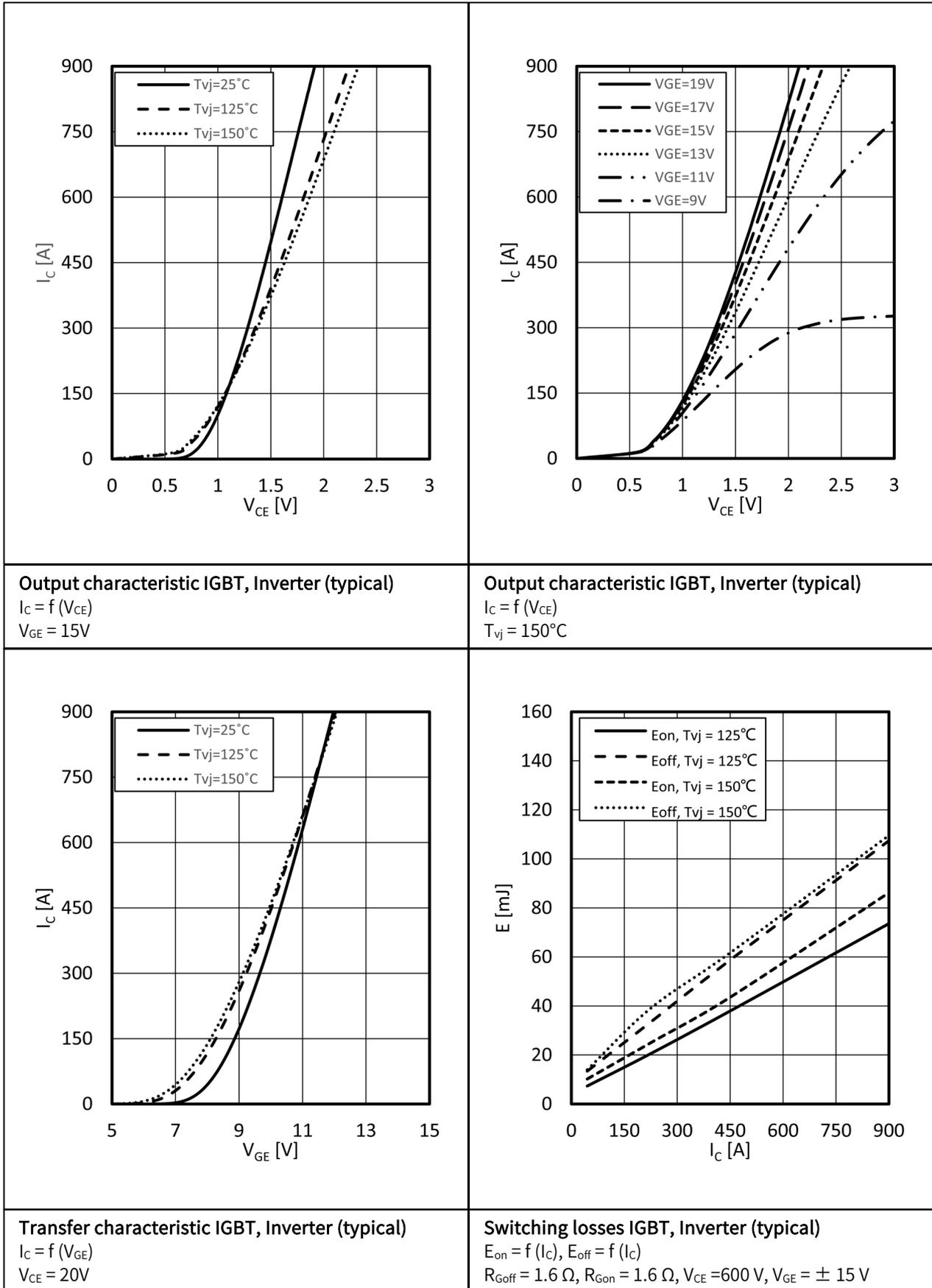
6.1 Characteristic value

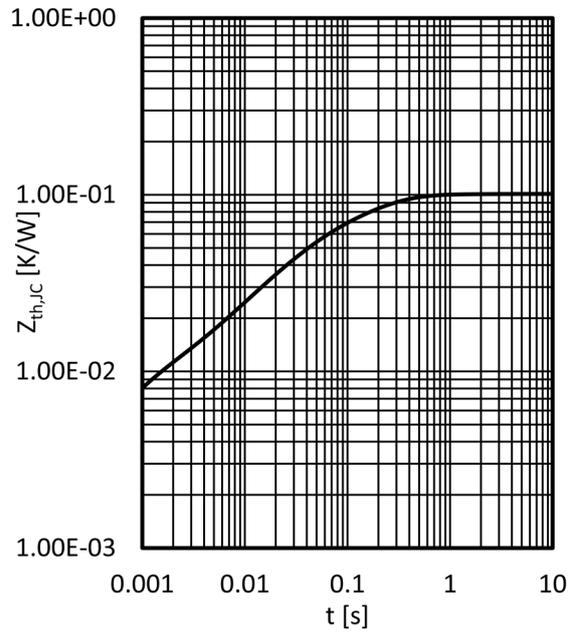
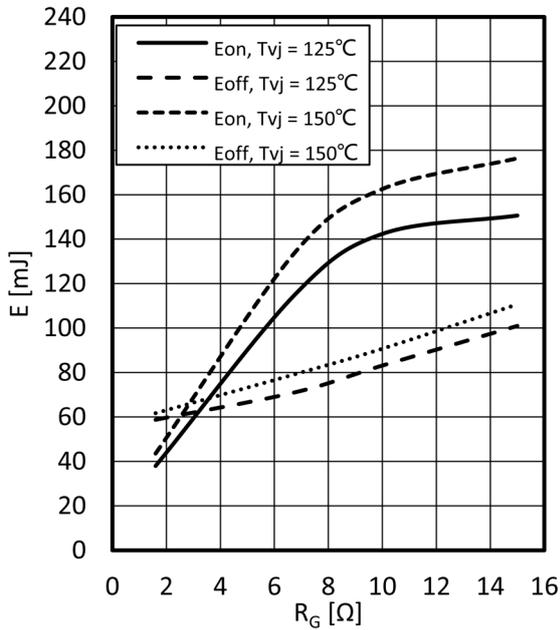
Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Isolation Voltage 隔离电压	RMS, f=50HZ,1min	V_{ISOL}			2500	V
Stray inductance module 杂散电感		L_{SCE}		20		nH

(table continues...) 待续

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Operation Junction Temperature 结温		T_{jop}	-40		150	$^\circ C$
Storage Temperature Range 存储温度范围		T_{stg}	-40		125	$^\circ C$
Mounting Torque 安装扭矩	Screw M6	M	3		6	N.m
Terminal Connection Torque 端子连接扭矩	Screw M6	M	2.5		5	N.m
Weight of Module 重量		G		340		g

7. Characteristics diagrams





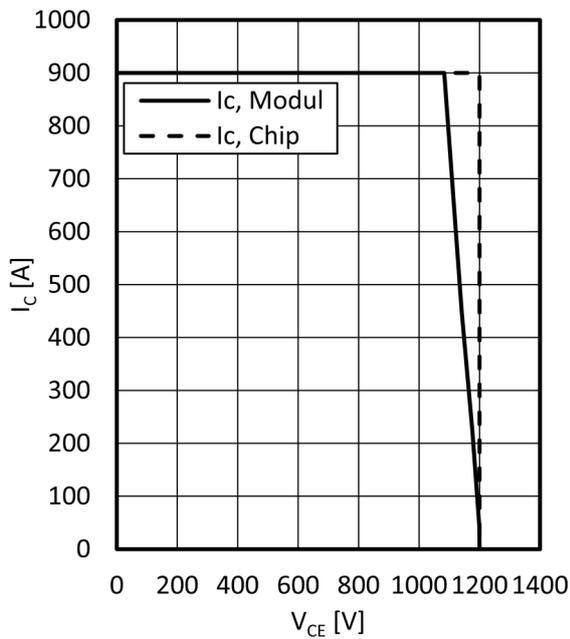
Switching losses IGBT, Inverter (typical)

$E_{on} = f(R_G), E_{off} = f(R_G)$

$I_C = 450 \text{ A}, V_{CE} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}$

Transient thermal impedance IGBT, Inverter

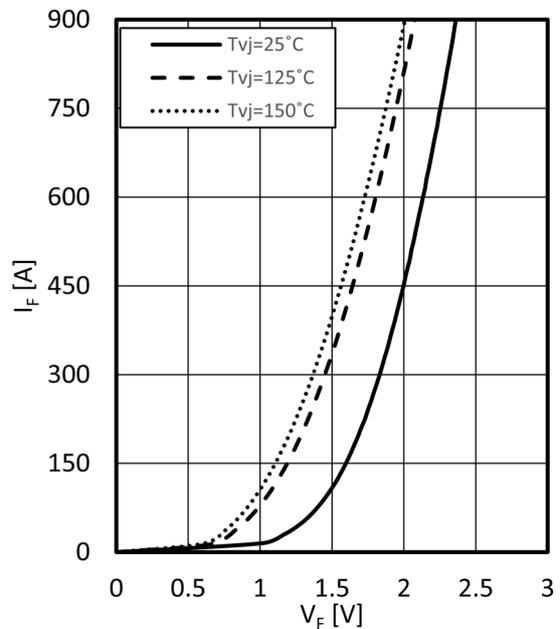
$Z_{th,jc} = f(t)$



Reverse bias safe operating area IGBT, Inverter (RBSOA)

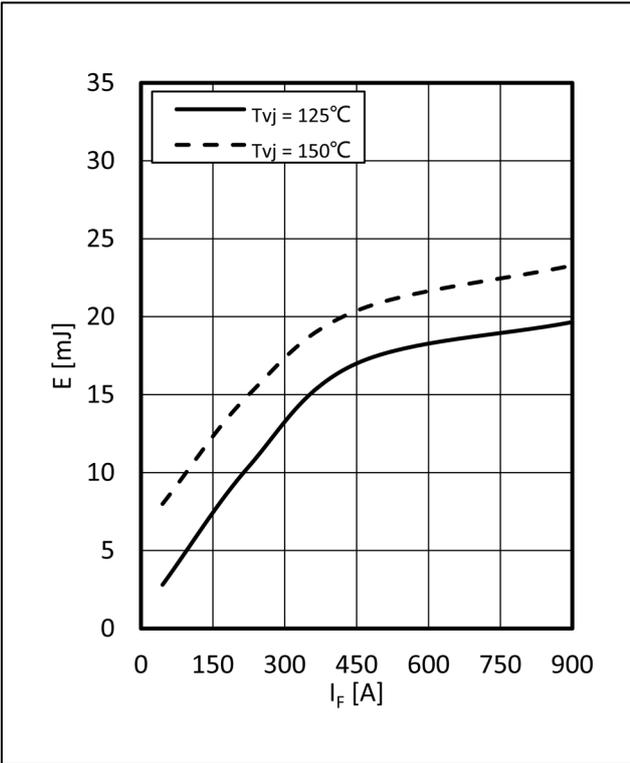
$I_C = f(V_{CE})$

$V_{GE} = \pm 15 \text{ V}, R_{Goff} = 1.6 \Omega, T_{vj} = 150 \text{ }^\circ\text{C}$

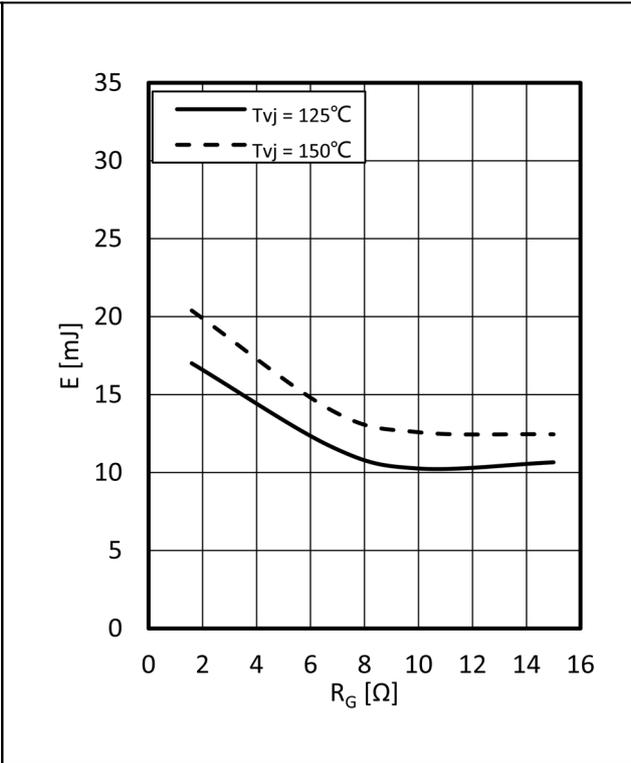


Forward characteristic of Diode, Inverter (typical)

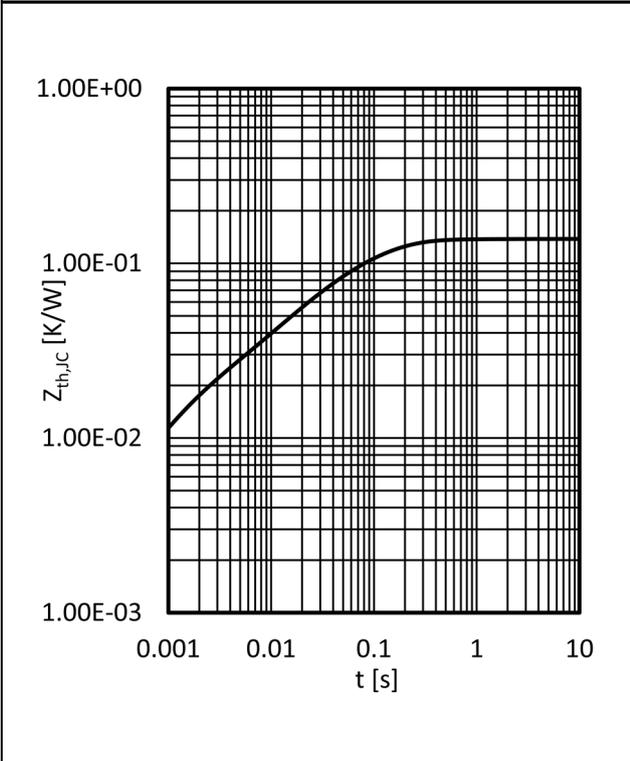
$I_F = f(V_F)$



Switching losses Diode, Inverter (typical)
 $E_{rec} = f(I_F)$
 $R_{Gon} = 1.6 \Omega, V_{CE} = 600 V$



Switching losses Diode, Inverter (typical)
 $E_{rec} = f(R_G)$
 $I_F = 450 A, V_{CE} = 600 V$



Transient thermal impedance Diode, Inverter
 $Z_{th,jc} = f(t)$

8. Circuit Diagram

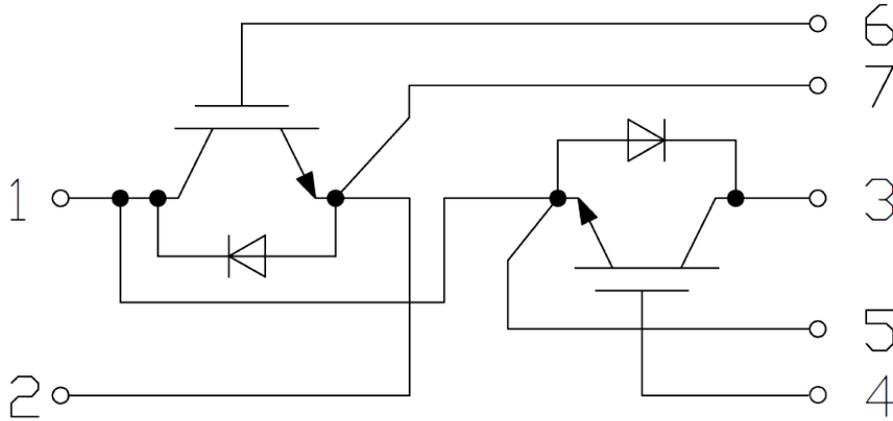


Figure 3

9. Package Outlines

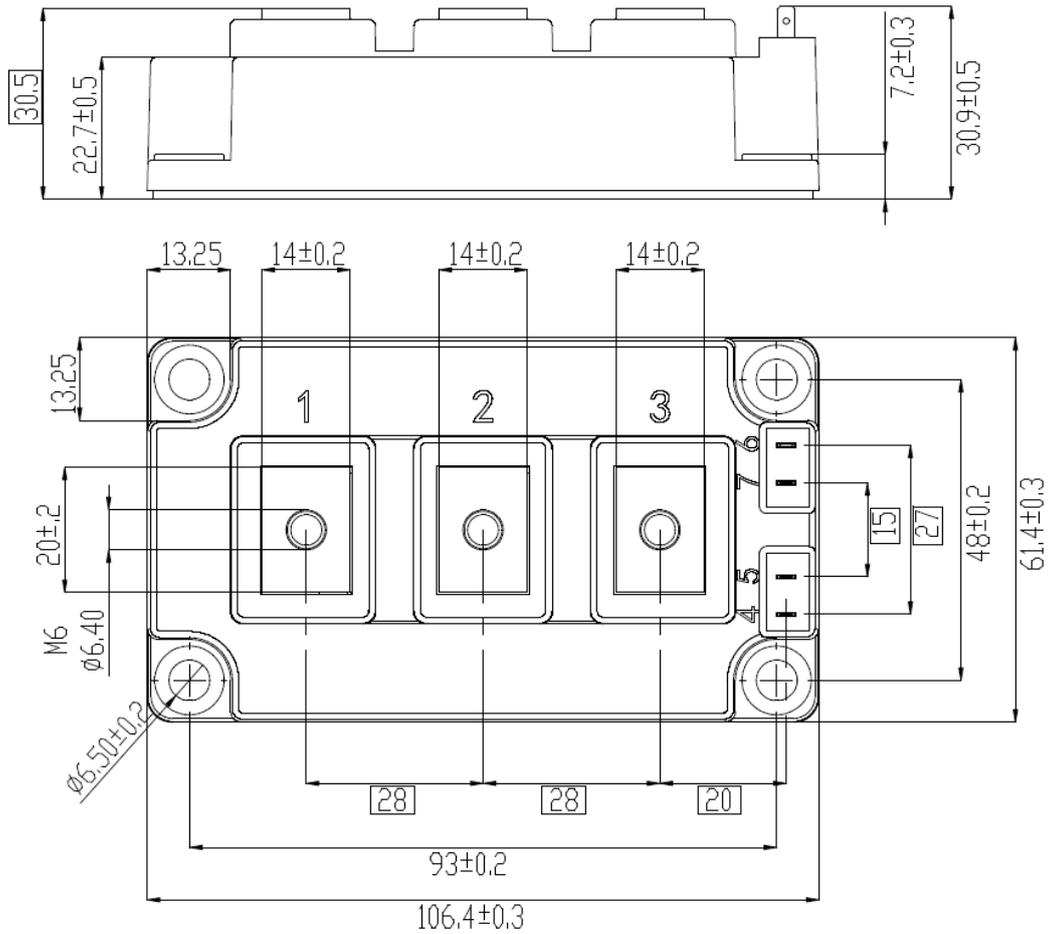


Figure 4